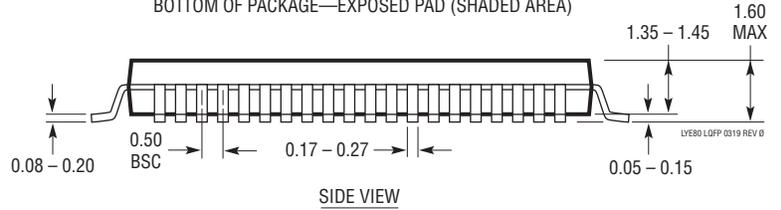
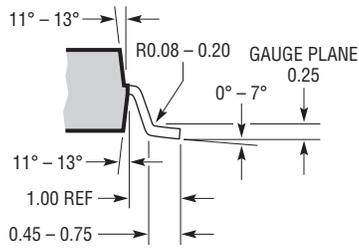
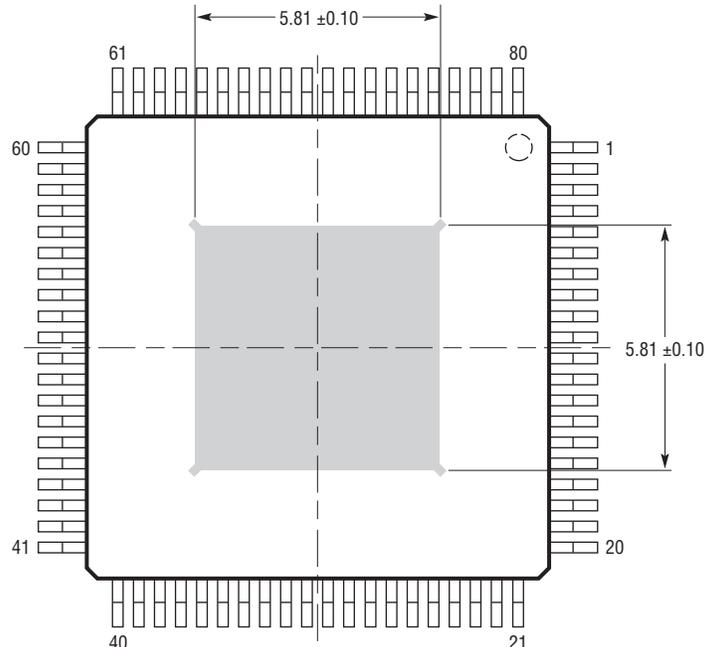
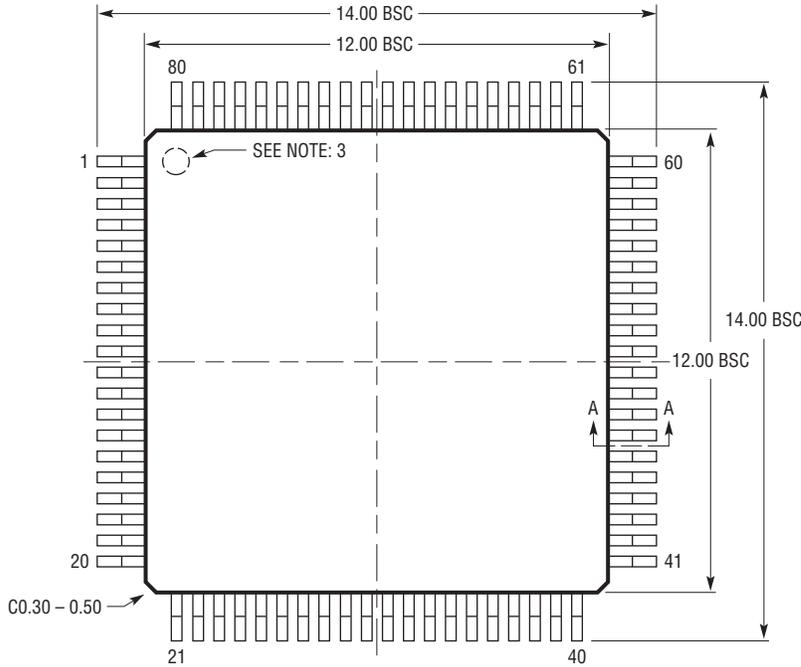
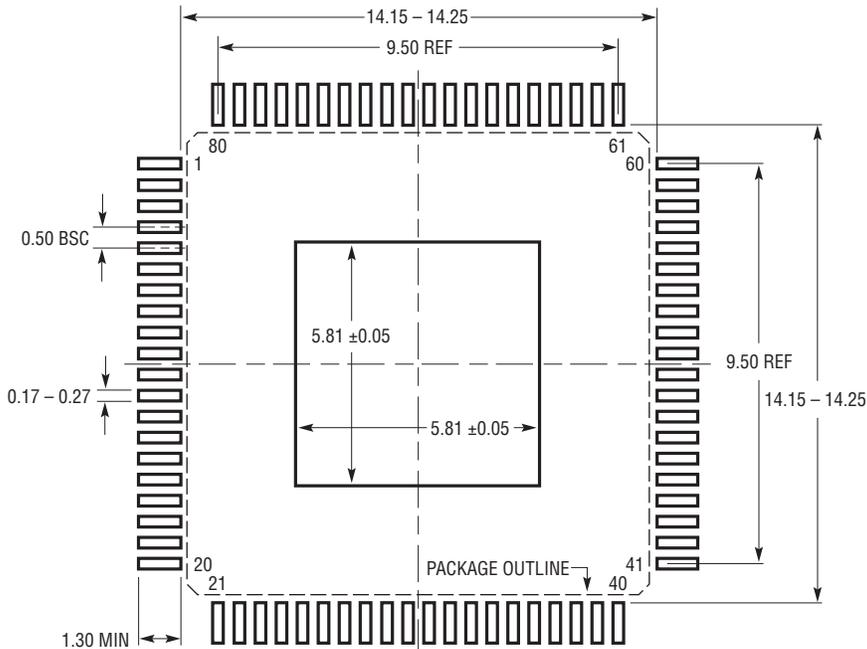


**LYE Package**  
**80-Lead Plastic Exposed Pad LQFP (12mm × 12mm)**  
 (Reference LTC DWG #05-08-1783 Rev 0)



**NOTE:**

1. DIMENSIONS ARE IN MILLIMETERS
2. DIMENSIONS OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.25mm (10 MILS) BETWEEN THE LEADS AND ON ANY SIDE OF EXPOSED PAD, MAX 0.50mm (20 MILS) AT CORNER OF EXPOSED PAD, IF PRESENT
3. PIN-1 IDENTIFIER IS A MOLDED INDENTATION
4. DRAWING IS NOT TO SCALE



RECOMMENDED SOLDER PAD LAYOUT  
 APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED

